

Applicant(s): Junichi ONOZAKI et al. Group Art Unit: 1725

JUN 2 1 2007

Appln. No. : 10/530,548 Examiner: BEVERIDGE, Rachel E.

Filed: April 7, 2005 Confirmation No.: 7630

For : SOLDER SUPPLYING METHOD

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents
U.S. Patent and Trademark Office
Customer Service Window, Mail Stop Amendment
Randolph Building
401 Dulany Street
Alexandria, VA 22314

Sir:

In accordance with the duty of disclosure under 37 C.F.R. §1.56 and §§1.97-1.98 and supplemental to the Information Disclosure Statement that was previously filed on July 8, 2005, Applicants hereby bring to the attention of the Examiner a Korean Office Action dated April 28, 2007, with respect to patent family member Korean Patent Application No. 20057007539, in which the following documents were cited:

- (1) Korean Patent Publication No. KR 100270837 B1, together with an English language Abstract thereof and patent family member U.S. Patent No. 6,070,788; and
- (2) Korean Patent Publication No. KR 100269834 B1, and patent family member U.S. Patent No. 5,125,560.

U6/22/2007 SZEWDIE1 UC000075 10530548 01 FC:1806 180.00 OP

The relevance of these documents, as ascertained with respect to the Korean claims by the Korean Examiner, is set forth in the partial English language Translation of the Korean Office Action.

Applicants further bring to the attention of the Examiner an European Supplementary Novelty Search Report dated May 7, 2007, with respect to patent family member European Patent Application No. 02788814.8, in which the following documents were cited:

- (3) United Kingdom Patent Publication No. GB 2 173 136 A;
- (4) Japanese Laid-Open Patent Publication No. HEI 3-226365 A, together with an English language Abstract thereof;
- (5) Japanese Laid-Open Patent Publication No. HEI 2-012830 A, together with an English language Abstract thereof;
- (6) Japanese Laid-Open Patent Publication No. HEI 7-114205 A, together with an English language Abstract thereof; and
- (7) United Kingdom Patent Publication No. GB 2 113 720 A.

The relevance of these documents, as ascertained with respect to the European claims by the European Examiner, is set forth in the European Supplementary Novelty Search Report.

Applicants note that above-noted document (6) was previously cited together with a translation in the Information Disclosure Statement filed on July 8, 2005 and has been considered by the Examiner on April 24, 2006. Thus, a copy of document (6) is not provided herewith.

Further to 37 C.F.R. §1.98 (a)(2)(ii), a copies of the U.S. Patent Publications are not enclosed herewith. However, if a copy is needed, the Examiner is respectfully requested to contact the undersigned.

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Applicants respectfully request that the Examiner consider the above material and cite the same. Copies of the above-noted foreign documents, including the noted English language

Abstracts are attached hereto, and all of the documents are listed on an attached Form PTO-1449.

Copies of the Korean Office Action and a partial English language translation thereof and the European Supplementary Novelty Search Report are also attached hereto. The Examiner is requested to initial the appropriate spaces on the attached PTO 1449 Form, and to return a copy of the completed Form to Applicants with the next official communication in the present application.

Since this Supplemental Information Disclosure Statement is being submitted subsequent to the issuance of a Final Rejection, Applicants have included herewith a check in the amount of \$180.00 to cover the fee set forth in 37 C.F.R. §1.17 (p).

Applicants furthermore certify that each item of information (except item 6) contained in this Information Disclosure Statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of the Information Disclosure Statement.

Should the Examiner have any questions, the Examiner is invited to contact the undersigned at the below-listed telephone number.

Respectfully submitted,

Junichi ONOZAKKet al.

William Pieprz Reg. No. 33,630

Bruce H. Bernstein

Reg. No. 29,027

June 20, 2007 GREENBLUM & BERNSTEIN, P.L.C. 1950 Roland Clarke Place Reston, VA 20191 (703) 716-1191

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*EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

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